

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Shunpei Yamazaki</td> <td>07/01/2010</td> </tr> <tr> <td>Junichiro Sakata</td> <td>06/25/2010</td> </tr> <tr> <td>Hiroyuki Miyake</td> <td>06/25/2010</td> </tr> <tr> <td>Hideaki Kuwabara</td> <td>06/23/2010</td> </tr> <tr> <td>Mari Terashima</td> <td>06/24/2010</td> </tr> </tbody> </table>		Name	Execution Date	Shunpei Yamazaki	07/01/2010	Junichiro Sakata	06/25/2010	Hiroyuki Miyake	06/25/2010	Hideaki Kuwabara	06/23/2010	Mari Terashima	06/24/2010
Name	Execution Date												
Shunpei Yamazaki	07/01/2010												
Junichiro Sakata	06/25/2010												
Hiroyuki Miyake	06/25/2010												
Hideaki Kuwabara	06/23/2010												
Mari Terashima	06/24/2010												
RECEIVING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Semiconductor Energy Laboratory Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>398, Hase</td> </tr> <tr> <td>City:</td> <td>Atsugi-shi, Kanagawa-ken</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>243-0036</td> </tr> </table>		Name:	Semiconductor Energy Laboratory Co., Ltd.	Street Address:	398, Hase	City:	Atsugi-shi, Kanagawa-ken	State/Country:	JAPAN	Postal Code:	243-0036		
Name:	Semiconductor Energy Laboratory Co., Ltd.												
Street Address:	398, Hase												
City:	Atsugi-shi, Kanagawa-ken												
State/Country:	JAPAN												
Postal Code:	243-0036												
PROPERTY NUMBERS Total: 1													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12835119</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12835119								
Property Type	Number												
Application Number:	12835119												
CORRESPONDENCE DATA													
Fax Number: (703)766-2394 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: (571) 434-6789 Email: scarr@riplo.com Correspondent Name: Eric J. Robinson Address Line 1: Robinson IP Law Office, P.C. Address Line 2: 3975 Fair Ridge Drive, Suite 20 North Address Line 4: Fairfax, VIRGINIA 22033													
ATTORNEY DOCKET NUMBER:	0756-8893												
NAME OF SUBMITTER:	Eric J. Robinson												

OP \$40.00 12835119

501230663

PATENT
REEL: 024673 FRAME: 0554

Total Attachments: 2

source=assignment#page1.tif

source=assignment#page2.tif

ASSIGNMENT

Serial No. _____

Filed _____

WHEREAS, Shunpei YAMAZAKI, Junichiro SAKATA, Hiroyuki MIYAKE, Hideaki KUWABARA and Mari TERASHIMA

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF for which an application for Letters Patent of the United States of America has been executed by the undersigned on _____, and;

WHEREAS, Semiconductor Energy Laboratory Co., Ltd. of 398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan and its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

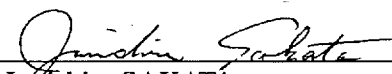
The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from

said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

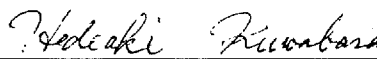
The undersigned hereby grant(s) the law firm of ROBINSON INTELLECTUAL PROPERTY LAW OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 07/01/2010 Signature 
Name Shunpei YAMAZAKI

Date 06/25/2010 Signature 
Name Junichiro SAKATA

Date 06/25/2010 Signature Hiroyuki MIYAKE
Name Hiroyuki MIYAKE

Date 06/23/2010 Signature 
Name Hideaki KUWABARA

Date 06/24/2010 Signature Mari Terashima
Name Mari TERASHIMA

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed has (have) invented certain new and useful improvements in by at least two other persons who should sign here.

Witness _____ Signature _____

Witness _____ Signature _____

Witness _____ Signature _____